

TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV821M5	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMV821M5/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMV821M5X	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMV821M5X/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LMV821M7	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LMV821M7/NOPB	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LMV821M7X/NOPB	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LMV822MM	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMV822MM/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMV822MMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMV822MX	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LMV822MX/NOPB	SOIC	D	8	2500	330.0	12.4	6.5	5.4	2.0	8.0	12.0	Q1
LMV822Q1MM/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMV822Q1MMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMV824MTX	TSSOP	PW	14	2500	330.0	12.4	6.95	5.6	1.6	8.0	12.0	Q1
LMV824MTX/NOPB	TSSOP	PW	14	2500	330.0	12.4	6.95	5.6	1.6	8.0	12.0	Q1

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMV824MX/NOPB	SOIC	D	14	2500	330.0	16.4	6.5	9.35	2.3	8.0	16.0	Q1
LMV824NDGVR	TVSOP	DGV	14	2000	330.0	12.4	6.8	4.0	1.6	8.0	12.0	Q1
LMV824Q1MAX/NOPB	SOIC	D	14	2500	330.0	16.4	6.5	9.35	2.3	8.0	16.0	Q1
LMV824Q1MTX/NOPB	TSSOP	PW	14	2500	330.0	12.4	6.95	5.6	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV821M5	SOT-23	DBV	5	1000	208.0	191.0	35.0
LMV821M5/NOPB	SOT-23	DBV	5	1000	208.0	191.0	35.0
LMV821M5X	SOT-23	DBV	5	3000	208.0	191.0	35.0
LMV821M5X/NOPB	SOT-23	DBV	5	3000	208.0	191.0	35.0
LMV821M7	SC70	DCK	5	1000	208.0	191.0	35.0
LMV821M7/NOPB	SC70	DCK	5	1000	208.0	191.0	35.0
LMV821M7X/NOPB	SC70	DCK	5	3000	208.0	191.0	35.0
LMV822MM	VSSOP	DGK	8	1000	208.0	191.0	35.0
LMV822MM/NOPB	VSSOP	DGK	8	1000	208.0	191.0	35.0
LMV822MMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LMV822MX	SOIC	D	8	2500	367.0	367.0	35.0
LMV822MX/NOPB	SOIC	D	8	2500	367.0	367.0	35.0
LMV822Q1MM/NOPB	VSSOP	DGK	8	1000	208.0	191.0	35.0
LMV822Q1MMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0
LMV824MTX	TSSOP	PW	14	2500	367.0	367.0	35.0
LMV824MTX/NOPB	TSSOP	PW	14	2500	367.0	367.0	35.0
LMV824MX/NOPB	SOIC	D	14	2500	356.0	356.0	35.0
LMV824NDGVR	TVSOP	DGV	14	2000	356.0	356.0	35.0

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMV824Q1MAX/NOPB	SOIC	D	14	2500	367.0	367.0	35.0
LMV824Q1MTX/NOPB	TSSOP	PW	14	2500	367.0	367.0	35.0

TUBE


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
LMV822M	D	SOIC	8	95	495	8	4064	3.05
LMV822M	D	SOIC	8	95	495	8	4064	3.05
LMV822M/NOPB	D	SOIC	8	95	495	8	4064	3.05
LMV824M/NOPB	D	SOIC	14	55	495	8	4064	3.05
LMV824MT/NOPB	PW	TSSOP	14	94	495	8	2514.6	4.06
LMV824MT/NOPB	PW	TSSOP	14	94	530	10.2	3600	3.5
LMV824Q1MA/NOPB	D	SOIC	14	55	495	8	4064	3.05
LMV824Q1MT/NOPB	PW	TSSOP	14	94	495	8	2514.6	4.06